



BRCF016GWZ-3E2 Information



For Reference Only

Part Number BRCF016GWZ-3E2

Manufacturer Rohm Semiconductor

Category Integrated Circuits (ICs)

Memory

DescriptionWL-CSP EEPROM**Package**4-XFBGA, CSPBGA

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









BRCF016GWZ-3E2 Specifications

	Report errors?
Supplier Device Package	UCSP30L1
Package / Case	4-XFBGA, CSPBGA
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Voltage - Supply	1.7 V ~ 5.5 V
Access Time	-
Write Cycle Time - Word, Page	5ms
Clock Frequency	1MHz
Memory Interface	I ² C
Memory Size	16Kb (2K x 8)
Technology	EEPROM
Memory Format	EEPROM
Memory Type	Non-Volatile
Series	-
Package	4-XFBGA, CSPBGA
	Memory
Category	Integrated Circuits (ICs)
Manufacturer	Rohm Semiconductor
Manufacturer Part Number	BRCF016GWZ-3E2

BRCF016GWZ-3E2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BRCF016GWZ-3E2 Payment Methods









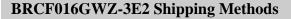
























If you have any question about BRCF016GWZ-3E2, please do not hesitate to contact us!

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